

| D |                          | E                   |                                     | F                         |   |
|---|--------------------------|---------------------|-------------------------------------|---------------------------|---|
|   |                          |                     |                                     |                           | 1 |
| F | R4<br>DNP<br>R5<br>DNP   |                     | <br>5V / 10W                        |                           | 2 |
|   | R6 DNP<br>R3<br>DNP<br>T |                     |                                     |                           | 3 |
|   |                          | Title               | Texas Instrum<br>Secondary Card for |                           | 4 |
|   |                          | Size M<br>C<br>Date | Number<br>PMP8363_S<br>10/01/2012   | EC Rev<br>Drawn by B KING | D |
|   | Engineer B KING          |                     | IP8363_SEC_REVD.sch                 | Sheet 1 of 1              |   |
| D |                          | E                   |                                     | F 10/1/201                | 2 |

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